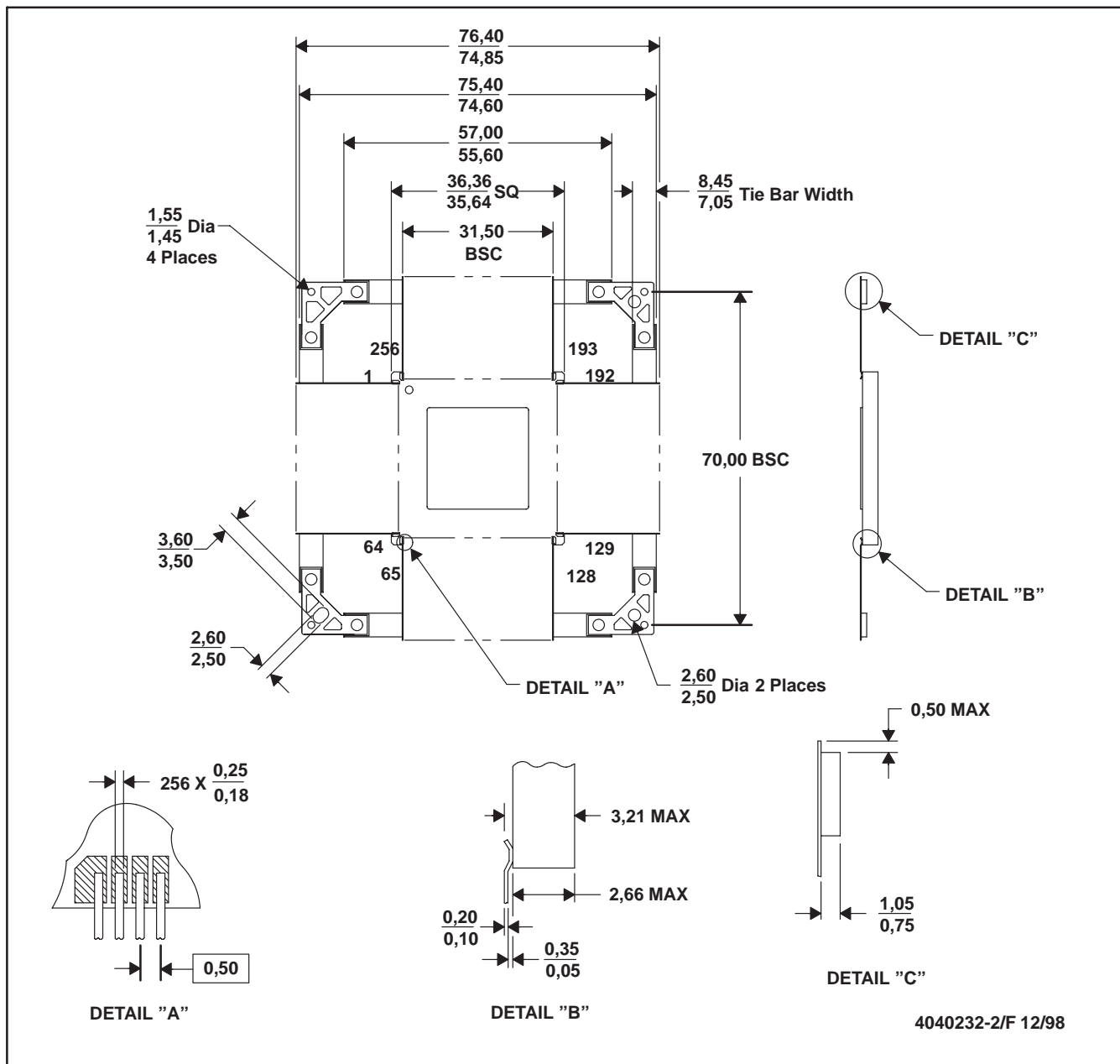


HFH (R-CQFP-F256)

CERAMIC QUAD FLATPACK WITH NCTB



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. This package is hermetically sealed with a metal lid.  
 D. The terminals are gold-plated.  
 E. Leads not shown for clarity purposes  
 F. Falls within JEDEC MO-134AB

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